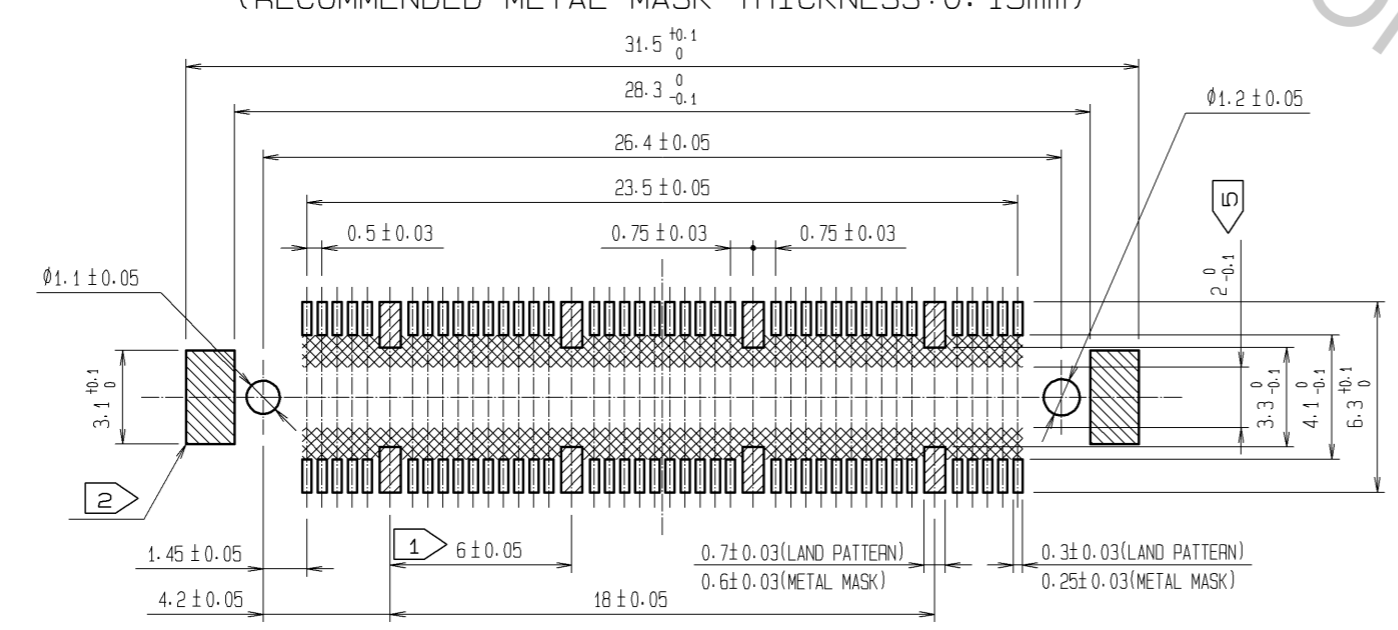


RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)



- NOTES
- ① 8 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

2	PHOSPHOR BRONZE	TIN-PLATING		4	PHOSPHOR BRONZE	TIN-PLATING		
1	LCP	BEIGE UL94V-0		3	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1μm min. LEAD AREA: TIN-PLATING 1μm min. UNDER PLATING: NICKEL 1μm min.		
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS	
UNITS	mm	SCALE	4 : 1	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
APPROVED : HS. OKAWA		08.06.26		DRAWING NO.		EDC3-151960-25		
CHECKED : HT. YAMAGUCHI		08.06.25		PART NO.		FX10A-80P/8-SV1(71)		
DESIGNED : SY. KAMIGA		08.06.23		CODE NO.		CL570-0101-0-71		1/1
DRAWN : HK. SUNADORI		08.06.17						